

## Features

- Provides ESD Protection per IEC 61000-4-2 Standard:  
Air  $\pm 30\text{kV}$ , Contact  $\pm 30\text{kV}$
- 1 Channel of ESD Protection
- High Peak Pulse Current per IEC 61000-4-5 Standard
- Low Channel Input Capacitance
- Typically Used in Cellular Handsets, Portable Electronics, Communication Systems, Computers and Peripherals
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **An automotive-compliant part is available under separate datasheet ([DESD5V0S1BAQ](#))**

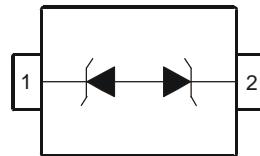
## Mechanical Data

- Package: SOD323
- Package Material: Molded Plastic, "Green" Molding Compound.
- UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 e3
- Weight: 0.005 grams (Approximate)

SOD323



Top View



Device Schematic

## Ordering Information (Note 4)

Part Number	Package	Packing	
		Qty.	Carrier
DESD5V0S1BA-7	SOD323	3000	Tape & Reel

Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

## Marking Information



A / A = Product Type Marking Code

**Maximum Ratings** (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	$P_{PP}$	130	W	8/20μs, per Figure 1
Peak Pulse Current	$I_{PP}$	12	A	8/20μs, per Figure 1
ESD Protection – Contact Discharge	$V_{ESD\_Contact}$	±30	kV	IEC 61000-4-2 Standard
ESD Protection – Air Discharge	$V_{ESD\_Air}$	±30	kV	IEC 61000-4-2 Standard

**Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	$P_D$	200	mW
Thermal Resistance, Junction to Ambient (Note 5)	$R_{0JA}$	625	°C/W
Operating and Storage Temperature Range	$T_J, T_{STG}$	-55 to +150	°C

**Electrical Characteristics** (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Conditions
Reverse Standoff Voltage	$V_{RWM}$	—	—	5	V	—
Channel Leakage Current (Note 6)	$I_{RM}$	—	5	100	nA	$V_{RWM} = 5\text{V}$
Clamping Voltage	$V_{CL}$	—	—	10	V	$I_{PP} = 1\text{A}, t_p = 8/20\mu\text{s}$
Breakdown Voltage	$V_{BR}$	5.5	—	9.5	V	$I_{PP} = 12\text{A}, t_p = 8/20\mu\text{s}$
Differential Resistance	$R_{DIF}$	—	0.4	—	Ω	$I_R = 1\text{mA}$
Channel Input Capacitance	$C_T$	—	35	45	pF	$V_R = 0, f = 1\text{MHz}$

Notes:

- 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes Incorporated's suggested pad layout, which can be found on our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.
- 6. Short duration pulse test used to minimize self-heating effect.

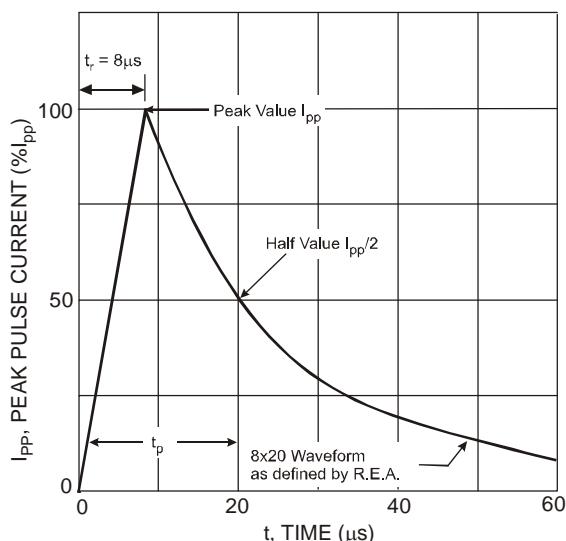


Figure 1. Pulse Waveform

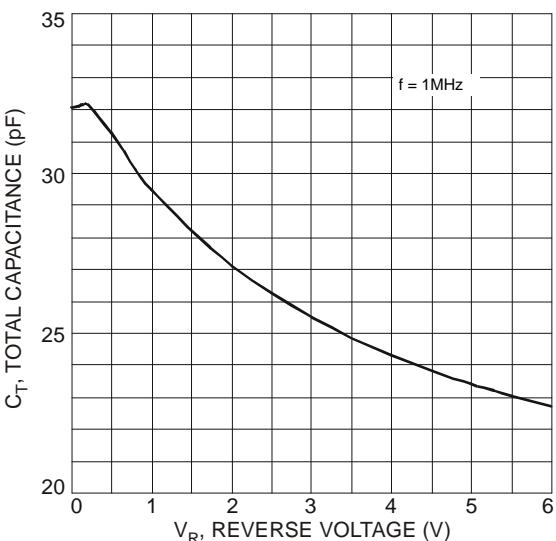


Figure 2. Typical Total Capacitance vs. Reverse Voltage

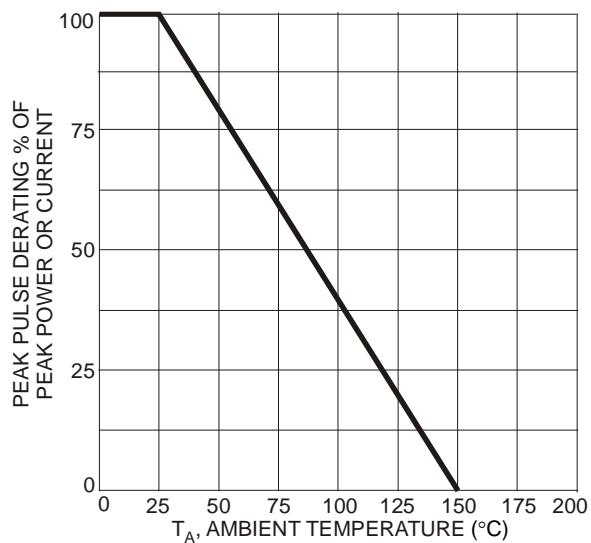


Figure 3. Power Dissipation vs. Ambient Temperature

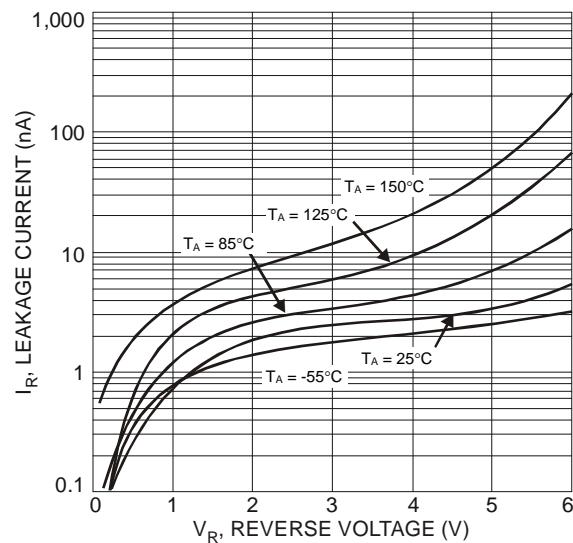
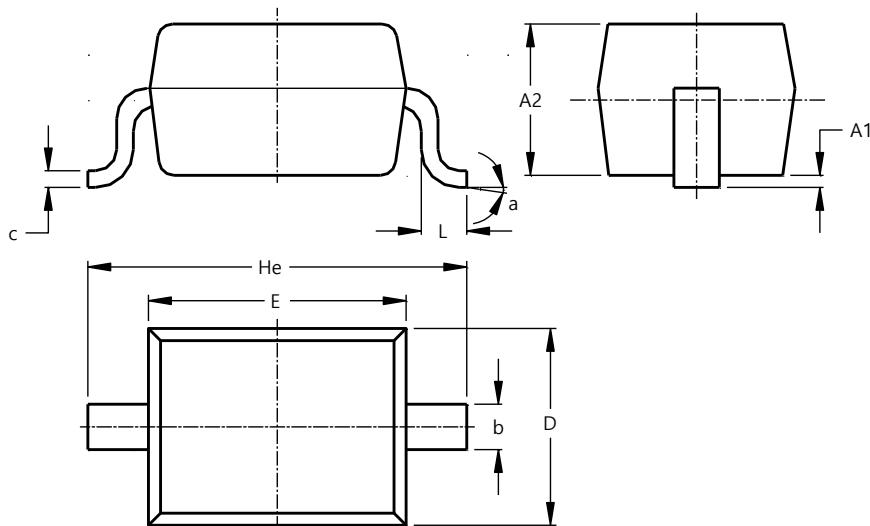


Figure 4. Typical Reverse Characteristics

## Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOD323



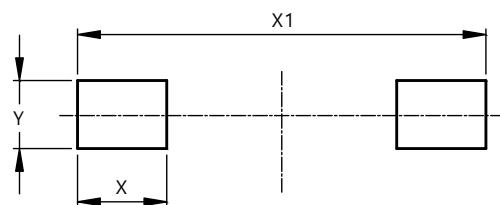
SOD323			
Dim	Min	Max	Typ
A1	--	0.10	0.05
A2	1.00	1.10	1.05
b	0.25	0.35	0.30
c	0.10	0.15	0.11
D	1.20	1.40	1.30
E	1.60	1.80	1.70
He	2.30	2.70	2.50
L	0.20	0.40	0.30
a	0°	8°	--

All Dimensions in mm

## Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOD323



Dimensions	Value (in mm)
X	0.590
X1	2.700
Y	0.450

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